COMPACT AI Vehicle Series

Intelligent Machine Learning Unit with NVIDIA Jetson Xavier NX



IPC/COMPACT A3N - RM

This fanless COMPACT A3N generation is based on the NVIDIA Jetson Xavier NX processor module and offers a wide range of interface options.

The robust and uncompromising industrial design allows the implementation in the most demanding mobile Al applications and guarantees long term availability.

- Power over Ethernet (PoE+), 48VDC out
- 24/7 continuous operation
- 6 total LAN Interfaces with individual NIC's
- Passively cooled, no moving parts
- Long term availability with fixed BOM



Product Highlights

Maintenance free
Power Ignition Controller
Shock and vibration resistant
Each LAN interface has its own dedicated NIC
LTE, GNSS and Wi-Fi connectivity options
No moving parts / passively cooled

Product Features

384-core NVIDIA Volta™ GPU with 48 Tensor Cores 6-Core ARM v8.2 64-bit NVIDIA Carmel CPU 8GB 128-bit LPDDR4x RAM soldered on board M.2 NVMe slot for storage expansion up to 2TB Ethernet, USB, RS232 Passive or Active CAN Optional LTE, GNSS & WiFi extensions Aluminum & Stainless steel housing

Markets / Applications

Autonomous Mobile Robots (AMRs) Automotive Transportation Robotics CCTV



Processor module / Performance			
NVIDIA Jetson Xavier NX 384-core NVIDIA Volta™ GPU with 48 Tensor Cores		•	•
6-Core ARM v8.2 64-bit NVIDIA Carmel CPU		•	•
Al Performance (INT8)		21 TOPs	21 TOPs
Memory / Storage			
Data Cache Size		2MB	2MB
128-bit LPDDR4x RAM soldered on board		8GB	8GB
eMMC 5.1 Flash Storage on board		16GB	16GB
M.2 2280 NVMe SSD Cactus Technologies 270P Series (R/W: 1.6GB/s 1.0GB/s)		256GB	256GB
microSD card socket ²		1	1
Features			
Inertial measurement unit (IMU) STMicroelectronics ISM330DHCXTR		•	<u> </u>
Real time clock (RTC) with battery backup Renata CR2477N (950mAh)		•	•
Hardware Watchdog & Temperature supervisor		•	•
Communication Interfaces			
Graphic interface behind the service cover		DisplayPort 1.4	DisplayPort 1.4
Internal USB version 2.0 OTG behind the service cover	(micro USB Type AB)	1	1
USB version 2.0 behind the service cover	(Type A)	2	2
Graphic interface		HDMI 2.0	HDMI 2.0
USB version 3.1 (10 Gbit/s)	(Type A)	1	1
USB version 2.01	(Type A)	optional	optional
Ethernet 10/100/1000 BASE-T (1x native, 1x I210-IT)	(M12 female, x-coded)	2	2
Power over Ethernet - IEEE802.3at 10/100/1000Mbit	(M12 female, x-coded)	<u>Ζ</u> <u>Λ</u>	4
PSE - Power sourcing equipment, producing 48VDC out	(W12 lemale, x-coded)	(total max power: 39W)	(total max power: 39W)
CAN 2.0A / CAN 2.0B (active/passive), CAN FD supported, isolated	(M12 female, a-coded)	(total max power. 3344)	1
Serial RS232 up to two ports available internally	(M12 male, a-coded)	I	I
	(W12 Male, a-coded)	ontional	l
Serial RS422/RS485	(um to A immute O A sutmute)	optional	optional
Digital I/O's, 24VDC	(up to 4 inputs & 4 outputs)	optional	optional
Analog input1, 0-20mA or -10+10V / 0 30V (16bit resolution Accuracy: +/- 0.1%)	(4 inputs)	optional	optional
Mini PCIe socket 2, used for extensions depending on configuration		2	2
I2C bus ²		1	1
Buzzer		1	1
MIPI CSI-2 / GMSL2 / FPDLinkIII Camera interface ¹		on request	on request
Wireless Connectivity			
Cellular Module (LTE/UMTS/GSM) with GNSS positioning functionality Sierra Wil	reless MC7455 - M2M only! (Dual nano SIM)	none	3x SMA
Wireless LAN IEEE 802.11a/b/g/n/ac dual-band 2x2 MIMO & Bluetooth 4.1 Spai		none	2x RP-SMA
High precision GNSS module 1 u-blox ZED-F9P module		optional	optional
Technical Data			
Dimensions [mm] (housing, excl. mounting)		w182 x h75 x d127	w182 x h75 x d127
Dimensions [mm] (housing, exc. mounting)		w218 x h75 x d127	w218 x h75 x d127
Net weight [gram]		~1700	~1700
Non isolated input voltage, with ignition controller, reverse polarity protected	(M12 male, a-coded)	9 45VDC	9 45VDC
Idle power consumption typ. in Watt @ 24V without Add-Ins	(W12 Male, a-coded)		
1 1 71 -		~13	~13
Environmental Conditions			
Operating temperature ³		−25°C +60°C	−25°C +60°C
Storage temperature		−25°C +85°C	−25°C +85°C
Ingress protection standard according to EN60529		IP40	IP40
Conformal coating ⁴		on request	on request
Road vehicles: UNECE-R10 (E-mark)		on request	on request
Shock (designed to meet)		EN60068-2-27	EN60068-2-27
Vibration (designed to meet)		EN60068-2-64	EN60068-2-64
EMI-Conformity (designed to meet)		EN55032 / EN55035	EN55032 / EN55035
Safety (designed to meet)		EN62368-1	EN62368-1
Radio and Telecommunication (designed to meet)		RED	RED
MTBF @ 25°C ambient according to Telecordia SR-332, Environment GB, excluding battery and SSD		~590 000h	~465 000h
		330 00011	100 00011
¹ Please contact factory for minimum order quantities			

Processor module / Performance

Product specifications subject to change without notice. | All data is for information purposes only and not guaranteed for legal purposes. Information in this data sheet has been carefully checked and is believed to be accurate. However, no responsibility is assumed for inaccuracies. Please refer to the user documentation for additional product specification.

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² Internal connector

³ Depending on installation situation and interface connection. Please see user documentation

⁴ On all possible components (excl. Xavier NX module, connectors and wireless devices)

⁵ It is possible to equip the products with a Cactus Technologies 270P Series NVMe SSD from the factory, use these part codes:

 $[|] PC/RMA3N119 - [G/H] \\ 2025 - 01 = 128GB | PC/RMA3N119 - [G/H] \\ 2025 - 02 = 256GB | PC/RMA3N119 - [G/H] \\ 2025 - 12GB | PC/RMA3N119 - [G/H] \\ 2025 - [G$